

### **STE180NE10**

N-channel 100V - 4.5mΩ - 180A - ISOTOP STripFET™ Power MOSFET

#### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STE180NE10	100V	<6m $\Omega$	180A

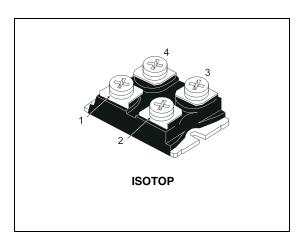
- 100% avalanche tested
- Low intrinsic capacitance
- Gate charge minimized
- Reduced voltage spread

### **Description**

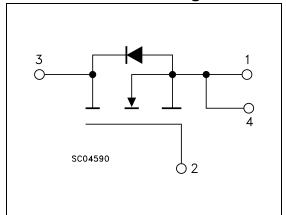
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

### **Applications**

Switching application



### Internal schematic diagram



#### **Order codes**

Part number	Marking	Package	Packaging	
STE180NE10	E180NE10	ISOTOP	Tube	

February 2007 Rev 6 1/12

Contents STE180NE10

# **Contents**

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuit	8
4	Package mechanical data	ć
5	Revision history 1	1

STE180NE10 Electrical ratings

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	100	V
V <sub>DGR</sub>	Drain-gate voltage ( $R_{GS} = 20k\Omega$ )	100	V
V <sub>GS</sub>	Gate-source voltage	± 20	٧
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25°C	180	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	119	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	360	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	360	W
	Derating factor	2.88	W/°C
V <sub>ISO</sub>	Insulation withstand voltage (AC-RMS)	2500	V
T <sub>j</sub> T <sub>stg</sub>	Operating junction temperature storage temperature	-55 to 150	°C

<sup>1.</sup> Pulse width limited by safe operating area

Table 2. Thermal data

Rthj-case	Thermal resistance junction-case max	0.37	°C/W	
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Table 3. Avalanche characteristics

Symbol	Parameter	Max value	Unit
I <sub>AR</sub>	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max)	60	A
E <sub>AS</sub>	Single Pulse Avalanche Energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 25$ V)	720	mJ

Electrical characteristics STE180NE10

## 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> =1mA, V <sub>GS</sub> =0	100			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = max rating $V_{DS}$ = max rating, $T_{C}$ = 125°C			4 40	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20V			±400	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10V, I_{D} = 40A$		4.5	6	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	$V_{DS}>I_{D(on)}xR_{DS(on)max}$ $I_{D}=80 A$	30			S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1MHz, V_{GS} = 0$		21 2.5 0.9		nF nF nF
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ = 90V, $I_{D}$ = 490A $R_{G}$ = 4.7 $\Omega$ $V_{GS}$ = 10V (see <i>Figure 12</i> )		100 600 430 440		ns ns ns
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ = 80V, $I_{D}$ = 180A, $V_{GS}$ = 10V, $R_{G}$ = 4.7 $\Omega$ (see <i>Figure 13</i> )		585 120 210	795	nC nC nC

<sup>1.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%.

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)				180 540	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 180A, V <sub>GS</sub> = 0			1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 100A,$ di/dt = 100A/ $\mu$ s, $V_{DD} = 50V, T_j = 150^{\circ}C$ (see <i>Figure 14</i> )		235 1.65 14		ns μC A

<sup>1.</sup> Pulse width limited by safe operating area.

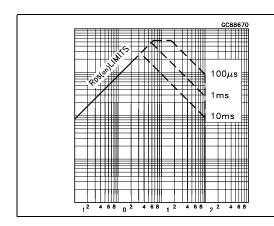
<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STE180NE10

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance



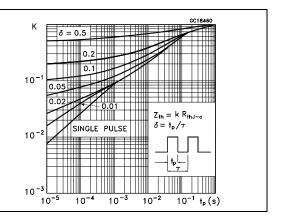
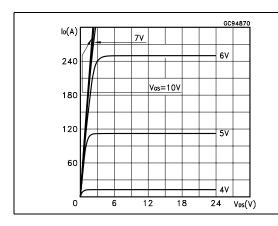


Figure 3. Output characteristics

Figure 4. Transfer characteristics



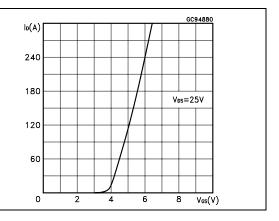
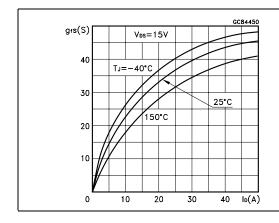


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



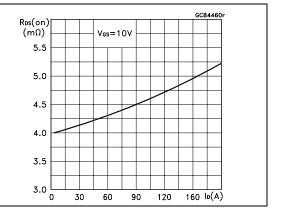


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

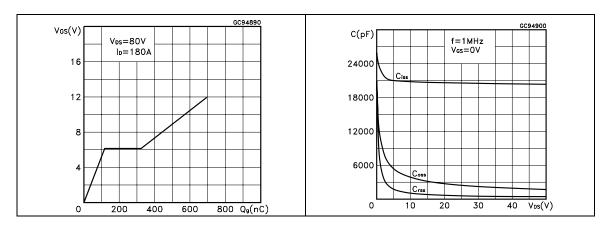


Figure 9. Normalized gate threshold voltage vs. temperature

Figure 10. Normalized on resistance vs. temperature

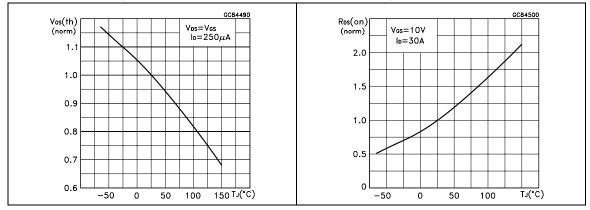
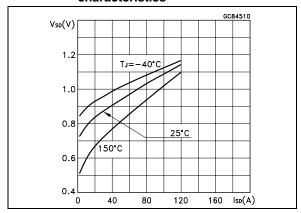


Figure 11. Source-drain diode forward characteristics



Test circuit STE180NE10

### 3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

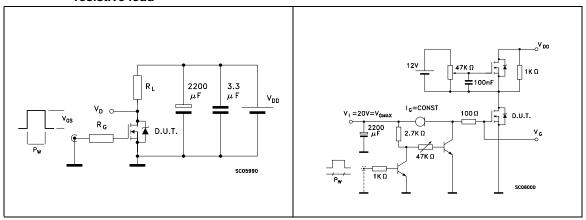


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

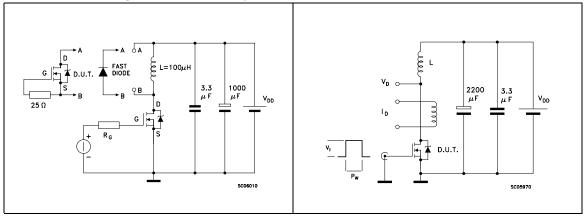
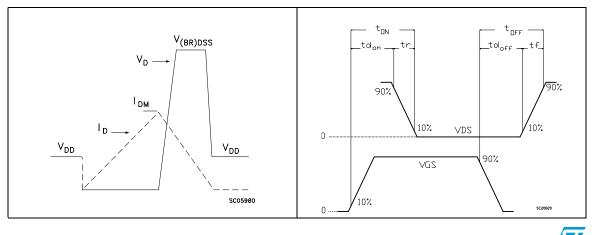


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



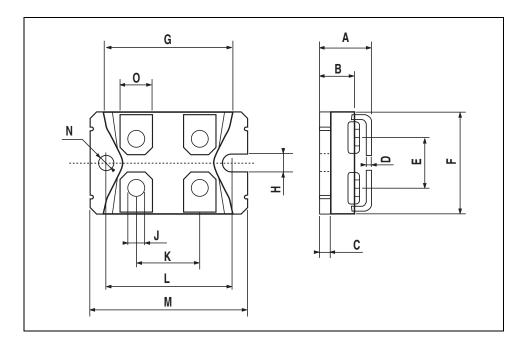
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

577

#### **ISOTOP MECHANICAL DATA**

DIM.	mm				inch	
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	11.8		12.2	0.466		0.480
В	8.9		9.1	0.350		0.358
С	1.95		2.05	0.076		0.080
D	0.75		0.85	0.029		0.033
Е	12.6		12.8	0.496		0.503
F	25.15		25.5	0.990		1.003
G	31.5		31.7	1.240		1.248
Н	4			0.157		
J	4.1		4.3	0.161		0.169
K	14.9		15.1	0.586		0.594
L	30.1		30.3	1.185		1.193
М	37.8		38.2	1.488		1.503
N	4			0.157		
0	7.8		8.2	0.307		0.322



STE180NE10 Revision history

# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
09-Sep-2004	4	Complete document
03-Aug-2006	5	New template, no content change
20-Feb-2007	6	Typo mistake on page 1

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577